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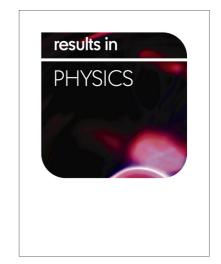
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Growth of YBa₂Cu₃O₇ Superconductor Thin Films using Ethanolamine-based Solutions via Simple Spin Coating

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